
THERMAL FET HAF2002

Silicon N Channel MOS FET Series
Power Switching / Over Temperature Shut-down Capability

HITACHI

ADE-208-503
1st. Edition

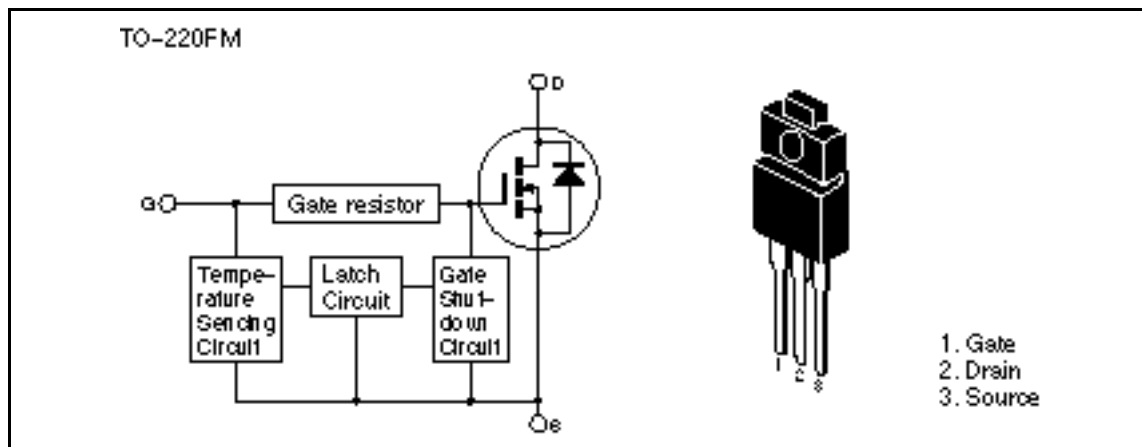
Features

This FET has the over temperature shut-down capability sensing to the junction temperature.

This FET has the built-in over temperature shut-down circuit in the gate area. And this circuit operation to shut-down the gate voltage in case of high junction temperature like applying over power consumption, over current etc.

- Logic level operation (4 to 6 V Gate drive)
- High endurance capability against to the short circuit
- Built-in the over temperature shut-down circuit
- Latch type shut-down operation (Need 0 voltage recovery)

Outline



HAF2002

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DS}	60	V
Gate to source voltage	V_{GSS+}	16	V
Gate to source voltage	V_{GSS-}	-2.8	V
Drain current	I_D	20	A
Drain peak current	$I_{D(pulse)}^{*1}$	40	A
Body to drain diode reverse drain current	I_{DR}	20	A
Channel dissipation	P_{ch}^{*2}	30	W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Notes: 1. PW 10μs, duty cycle 1 %
 2. Value at Tc = 25°C

Typical Operation Characteristics

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Input voltage	V_{IH}	3.5	—	—	V	
	V_{IL}	—	—	1.2	V	
Input current (Gate non shut down)	I_{IH1}	—	—	100	μA	$V_i = 8V, V_{DS} = 0$
	I_{IH2}	—	—	50	μA	$V_i = 3.5V, V_{DS} = 0$
	I_{IL}	—	—	1	μA	$V_i = 1.2V, V_{DS} = 0$
Input current (Gate non shut down)	$I_{IH(sd)1}$	—	0.8	—	mA	$V_i = 8V, V_{DS} = 0$
	$I_{IH(sd)2}$	—	0.35	—	mA	$V_i = 3.5V, V_{DS} = 0$
Shut down temperature	T_{sd}	—	175	—	°C	Channel temperature

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain current	I_{D1}	10	—	—	A	$V_{GS} = 3.5V, V_{DS} = 2V$
Drain current	I_{D2}	—	—	10	mA	$V_{GS} = 1.2V, V_{DS} = 2V$
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D = 10mA, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS+}$	16	—	—	V	$I_G = 100\mu A, V_{DS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS-}$	-2.8	—	—	V	$I_G = -100\mu A, V_{DS} = 0$
Gate to source leak current	I_{GSS+1}	—	—	100	μA	$V_{GS} = 8V, V_{DS} = 0$
	I_{GSS+2}	—	—	50	μA	$V_{GS} = 3.5V, V_{DS} = 0$
	I_{GSS+3}	—	—	1	μA	$V_{GS} = 1.2V, V_{DS} = 0$
	I_{GSS-}	—	—	-100	μA	$V_{GS} = -2.4V, V_{DS} = 0$
Input current (shut down)	$I_{GS(op)1}$	—	0.8	—	mA	$V_{GS} = 8V, V_{DS} = 0$
	$I_{GS(op)1}$	—	0.35	—	mA	$V_{GS} = 3.5V, V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	250	μA	$V_{DS} = 50V, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.25	V	$I_D = 1mA, V_{DS} = 10V$
Static drain to source on state resistance	$R_{DS(on)}$	—	50	65	m	$I_D = 10A, V_{GS} = 4V^{*1}$
Static drain to source on state resistance	$R_{DS(on)}$	—	30	43	m	$I_D = 10A, V_{GS} = 10V^{*1}$
Forward transfer admittance	$ y_{fs} $	6	12	—	S	$I_D = 10A, V_{DS} = 10V^{*1}$
Output capacitance	C_{oss}	—	630	—	pF	$V_{DS} = 10V, V_{GS} = 0$ $f = 1\text{ MHz}$
Turn-on delay time	$t_{d(on)}$	—	7.5	—	μs	$I_D = 5A, V_{GS} = 5V$
Rise time	t_r	—	29	—	μs	$R_L = 6$
Turn-off delay time	$t_{d(off)}$	—	34	—	μs	
Fall time	t_f	—	26	—	μs	
Body to drain diode forward voltage	V_{DF}	—	1.0	—	V	$I_F = 20A, V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	110	—	ns	$I_F = 20A, V_{GS} = 0$ $di_F/dt = 50A/\mu s$

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Electrical Characteristics (Ta = 25°C)

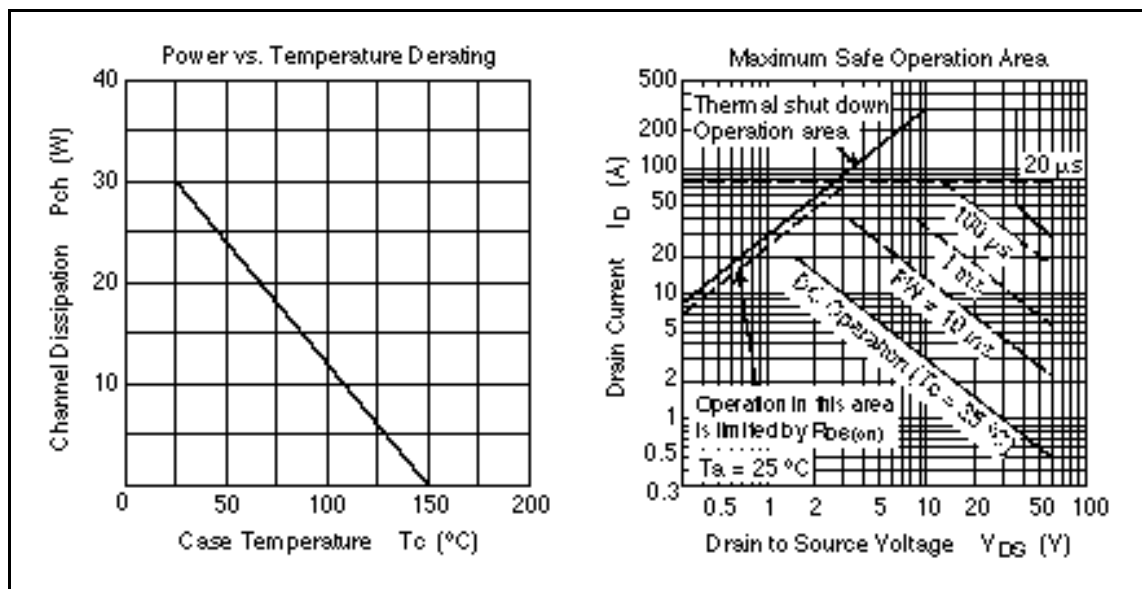
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Over load shut down	t_{os1}	—	1.8	—	ms	$V_{GS} = 5V, V_{DD} = 12V$
operation time *2	t_{os2}	—	0.7	—	ms	$V_{GS} = 5V, V_{DD} = 24V$

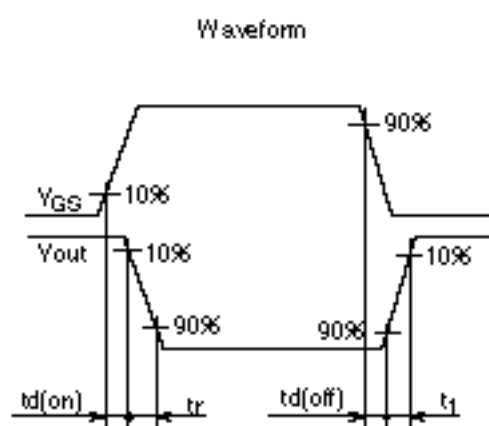
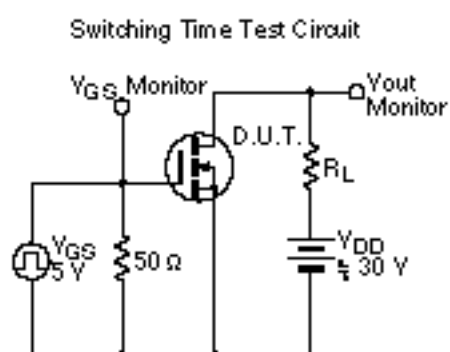
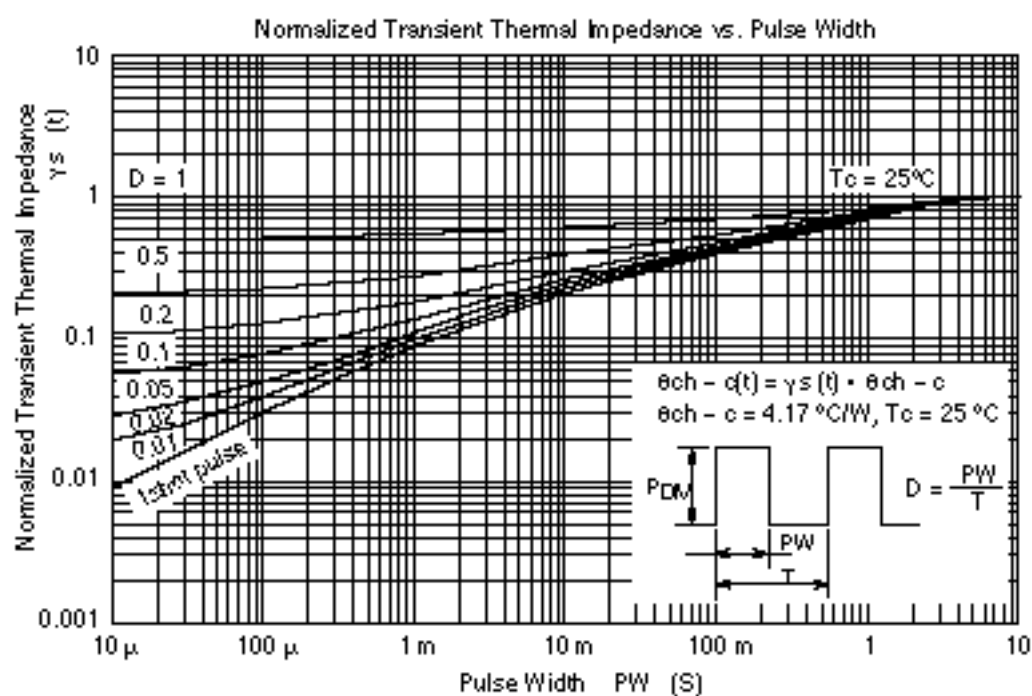
Notes: 1. Pulse test

2. Including the junction temperature raise of the over loaded condition.

- See characteristic curve of HAF2001.

Main Characteristics

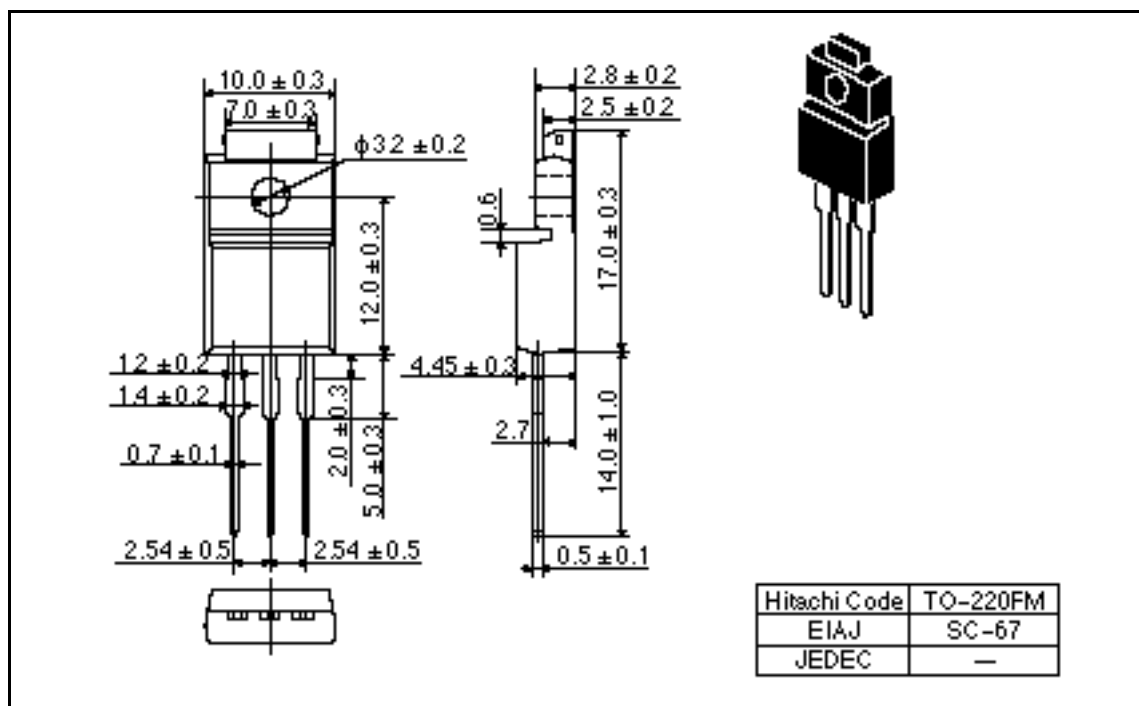




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Package Dimensions

Unit: mm



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